

**ATTENTION**

OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

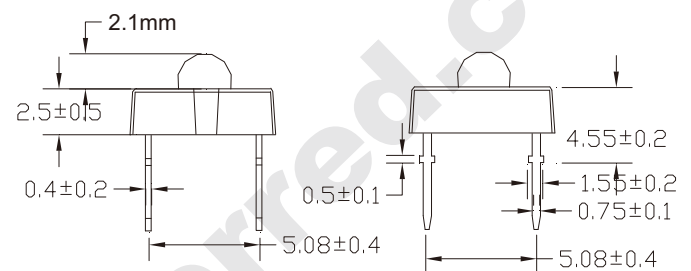
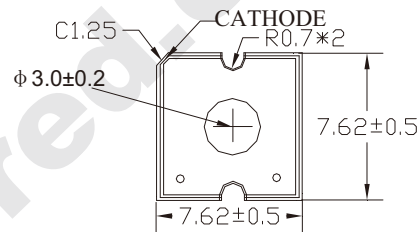
➤ Features/特征:

- Single color/单色
- High bright output/高亮度输出
- High reliability and long life/
可靠性高、寿命长
- Low power consumption/低功耗

➤ Descriptions/描述:

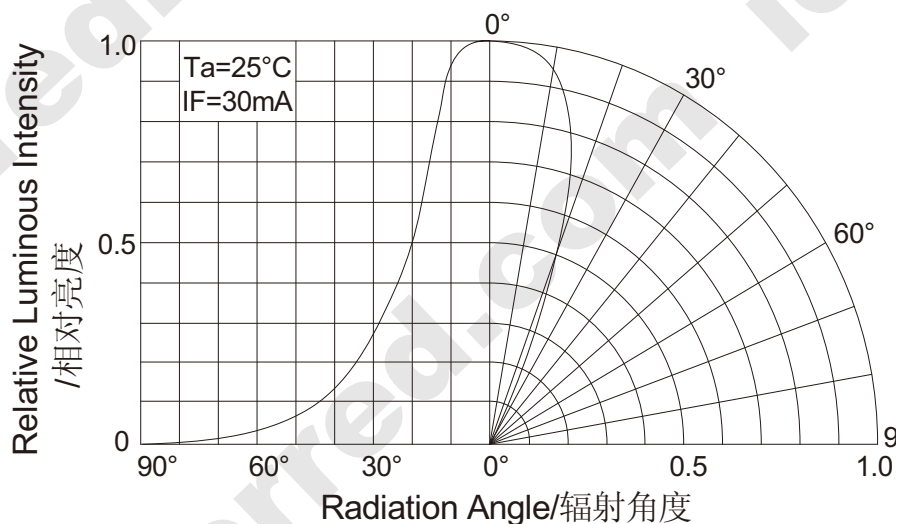
- Dice material/芯片材质: InGaN
- Emitting Color/发光颜色:
Super Bright White/ 高亮度白色
- Device Outline/产品外形:
7.62mmX7.62mm
- Lens Type 胶体颜色:
Water Clear/ 无色透明

➤ Directivity/指向特性:



1. All dimensions are millimeters/单位: mm.
2. Tolerance is +/-0.20mm unless otherwise noted/
没有标注的公差均为±0.20mm.

DIRECTIVITY/指向特性



➤ **Absolute maximum ratings/极限参数 (Ta = 25°C)**

Parameter 参数	Symbol 符号	Test Condition 测试条件	Values 数值		Unit 单位
			Min.	Max.	
Reverse Voltage 反向电压	V _R	I _R = 30 μA	5	--	V
Forward Current 正向工作电流	I _F	----	----	30	mA
Power Dissipation 损耗功率	P _d	----	----	110	mW
Pulse Current 正向峰值电流	I _{peak}	Duty=0.1mS, 1kHz	----	150	mA
Operating Temperature 工作温度范围	T _{opr}	----	-40	+85	°C
Storage Temperature 储存温度范围	T _{str}	----	-40	+100	°C

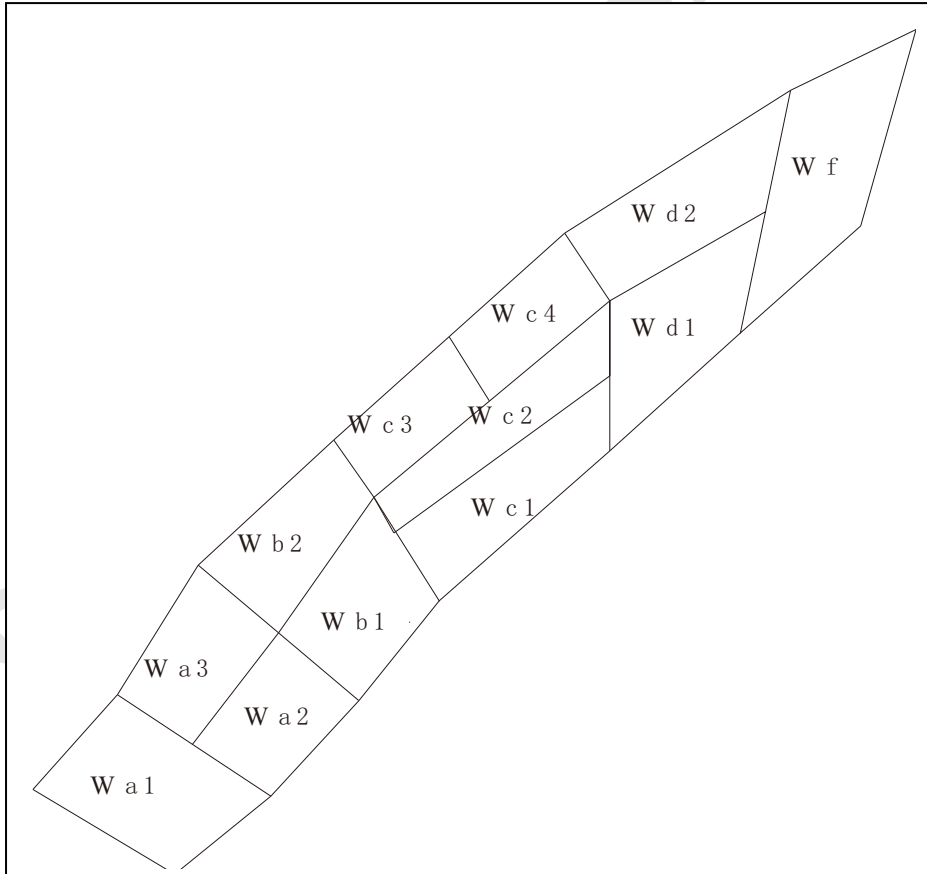
➤ **Electrical and optical characteristics/光电参数 (Ta = 25°C)**

Parameter 参数	Symbol 符号	Test Condition 测试条件	Values 数值			Unit 单位
			Min.	Typ.	Max.	
Forward Voltage 正向电压	V _F	I _F =30mA	----	3.3	3.8	V
Reverse Current 反向电流	I _R	V _R =5V	----	----	30	μA
Luminous Flux 光通量	φ _v	I _F =30mA	3	5.5	----	lm
Viewing Angle 指向角度	2θ 1/2	I _F = 30mA	----	40	----	Deg.

➤ **Luminous Intensity Bins Chart/光通量(Unit: lm) (Ta = 25°C)**

Bin	H	J	K	L	M
Min	2.2	2.8	3.6	4.7	6.0
Max	2.8	3.6	4.7	6.0	7.8

➤ Bin Grade Limits(IF=30mA) Characteristics (Ta=25°C)/分 BIN 图表



Wa1	X	0.243	0.215	0.230	0.263	Wa2	X	0.263	0.246	0.264	0.280
	Y	0.200	0.230	0.250	0.220		Y	0.220	0.236	0.267	0.248
Wa3	X	0.246	0.230	0.248	0.264	Wb1	X	0.280	0.264	0.283	0.296
	Y	0.236	0.250	0.286	0.267		Y	0.248	0.267	0.305	0.276
Wb2	X	0.264	0.248	0.275	0.283	Wc1	X	0.296	0.287	0.330	0.330
	Y	0.267	0.286	0.321	0.305		Y	0.276	0.295	0.339	0.318
Wc2	X	0.287	0.283	0.330	0.330	Wc3	X	0.283	0.275	0.298	0.306
	Y	0.295	0.305	0.360	0.339		Y	0.305	0.321	0.350	0.332
Wc4	X	0.306	0.298	0.321	0.330	Wd1	X	0.330	0.330	0.361	0.356
	Y	0.332	0.350	0.379	0.360		Y	0.318	0.360	0.385	0.351
Wd2	X	0.330	0.321	0.366	0.361	Wf	X	0.356	0.366	0.391	0.380
	Y	0.360	0.379	0.419	0.385		Y	0.351	0.419	0.436	0.381

➤ **Typical electrical/optical characteristic curves/光电特性曲线:**

Fig.1 正向电流 Vs. 正向电压

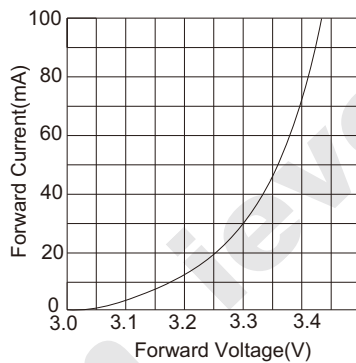


Fig.2 相对亮度 Vs. 正向电流

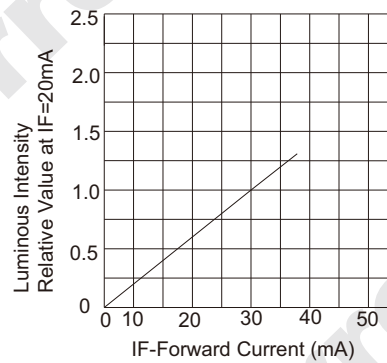


Fig.3 正向电流 Vs. 环境温度

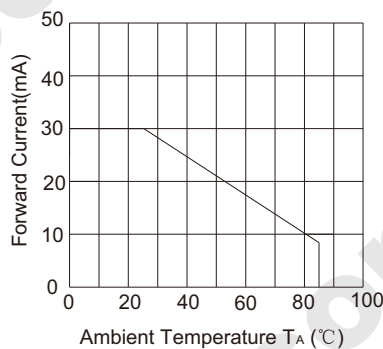
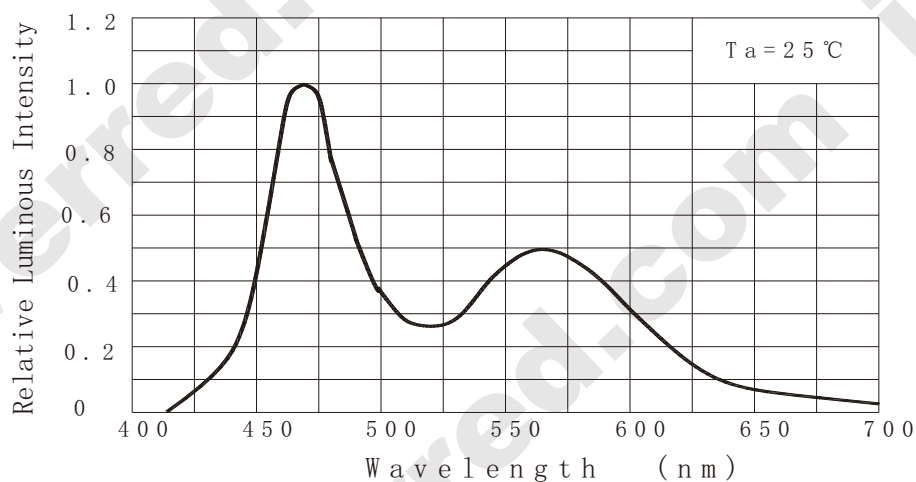
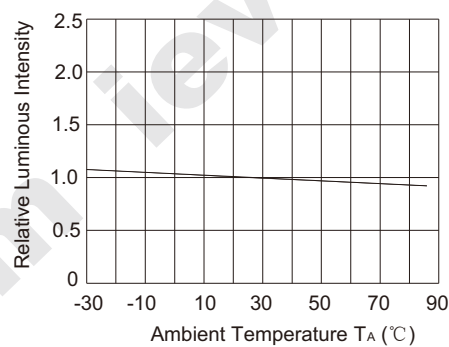



Fig.4 相对亮度 Vs. 环境温度



➤ Label Form Specification/标签格式规范

Everred Tech Ltd.	
P/N:	_____
Rank:	_____/_____/_____/_____
Qty:	_____ pcs
QC:	_____
Date:	_____
Lot No:	_____
	

P/N: Customer's Production Number/产品编号

QTY: Packing Quantity/包装数量

Ranks: Iv / Vf / WD

Iv: Iv Rank/亮度; Vf: Vf Rank/电压; WD: Color Group/色系

QC: Quality Control chapter/质量控制章

Date: mm / dd / yy

mm: Month/月; dd: Date/日; yy: Year/年;

Lot No: Production batch Number/生产批号

➤ Soldering Condition/焊接条件

Careful attention should be paid during soldering. When soldering, leave more than 2mm from solder joint to case, and soldering beyond the base of the tie bar is recommended.

焊接时请特别注意，焊接点要离LED封装体底部2mm以上。

Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.

在LED处于高温，特别是在焊接时，请避免对支架施压。

Recommended soldering conditions/推荐焊接条件:

Hand Soldering 手工焊接		DIP Soldering 浸焊	
Temp.at tip of iron 电烙铁温度	300℃ Max.(30W Max.) 最高温度300℃ (功率不超过30瓦)	Preheat temp. 预热温度	100℃ Max. (60 sec Max.) 最高温度100℃ (不超过60秒)
Soldering time 焊接时间	3 sec Max. 时间不超过3秒	Bath temp. 浸焊温度	260℃ Max 最高260℃.
Distance 焊接位置	2mm Min.(From solder joint to case) 大于2毫米 (从焊点到胶体)	Bath time. 浸焊时间	3 sec Max. 不超过3秒
		Distance 浸焊位置	2mm Min 大于2毫米.

➤ Cleaning/清洗

1. Do not clean LEDs with water, Alcohol are recommended solvents for cleaning. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the resin or not.

不要用水清洗，推荐使用酒精清洗，当使用其他溶剂清洗时应事先确认该溶剂是否溶解树脂。

2. LEDs may be damaged by ultrasonic-washed. Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

LED有可能在超声波清洗过程中被破坏。为了保证安全，在清洗前，请先确认。

➤ Storage/保存

1. Environmental temperature: -40℃---100℃, Recommended: -20℃---50℃

环境温度：-40℃---100℃，推荐使用-20℃---50℃；

2. Environmental humidity: 30%---70%, Recommended: 40%---60%

环境湿度：30%---70%，推荐使用40%---60%；

➤ Static Electricity/静电

1. Static Electricity or power surge will damage the LED.

It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.

静电或激增电压将损害 LED。

建议使用发光二极管时佩戴手腕带或防静电手套。

2. All production machinery and test instruments must be electrically grounded.

所有的生产机器和检测仪器，必须接地。

3. Maintain a humidity level of 50% or higher in production areas.

生产现场湿度必须保持在50%或者更高。

4. Use anti-static packaging for transport and storage.

使用防静电包装，运输和储存。

➤ Notes/备注

1. This datasheet will be update regularly, if there comes out any changes, pls confirmed by the latest datasheet.

以上规格书会定期进行更新，如有改动,以最新规格书为准。

2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Everred Tech Ltd. assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.